



VMDSEMI

VUSB006R35BNA

Datasheet



VMDSEMI

General Description

Symbol

$V_{(BR)DSS}$	$R_{DS(ON)_{max}}$	I_D
60V	3.5Ω@10V	0.34A
	4.0Ω@4.5V	

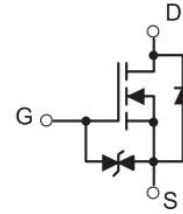
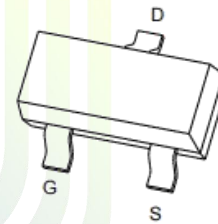


Figure 1 Symbol of VUSB006R35BNA

Features

- Surface Mount Package
- Voltage Controlled Small Signal Switch
- High Density Cell Design For Low $R_{DS(ON)}$
- Rugged and Reliable
- ESD Protected

Package Type



SOT-23

Application

- Power Switch Application
- Small Servo Motor Controls
- Power MOSFET Gate Drivers

Figure 2 Package Type of VUSB006R35BNA

Ordering Information

Product Name	Package
VUSB006R35BNA	SOT-23

Absolute Maximum Ratings ($T_A = 25\text{ °C}$, unless otherwise specified)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DSS}	60	V
Gate-Source Voltage	V_{GSS}	± 20	V
Continuous Drain Current ^{Note1}	I_D	0.34	A
Pulsed Drain Current ^{Note2}	I_{DM}	1.36	
Total Power Dissipation ^{Note4}	P_D	0.35	W
Junction Temperature	T_J	150	°C
Storage Temperature	T_{STG}	-55 to 150	°C

Thermal Resistance

Parameter	Symbol	Min	Typ	Max	Unit
Thermal Resistance, Junction-to-Ambient ^{Note5}	$R_{\theta JA}$		350		°C/W



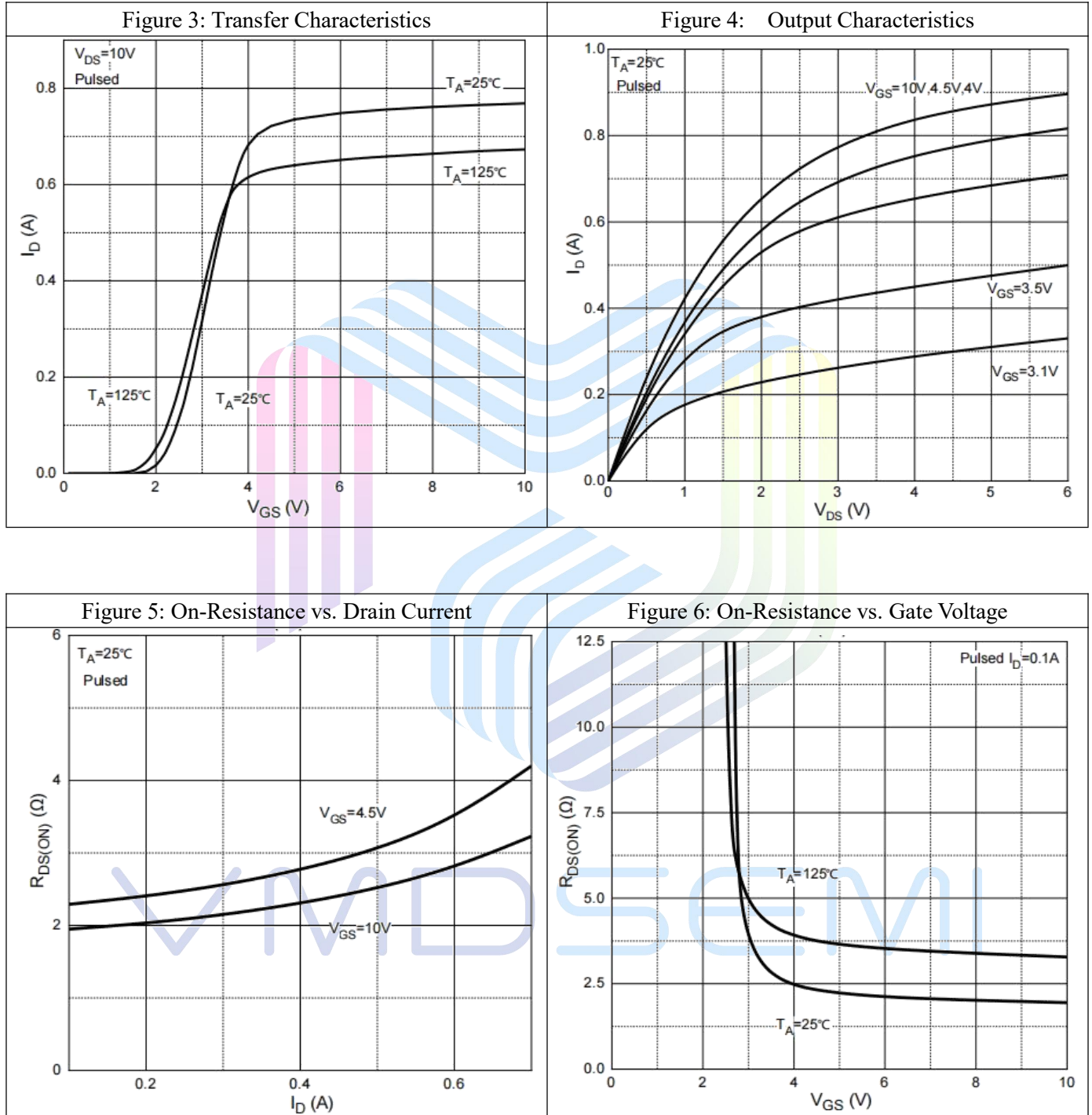
Electrical Characteristics ($T_J = 25\text{ }^\circ\text{C}$, unless otherwise specified)

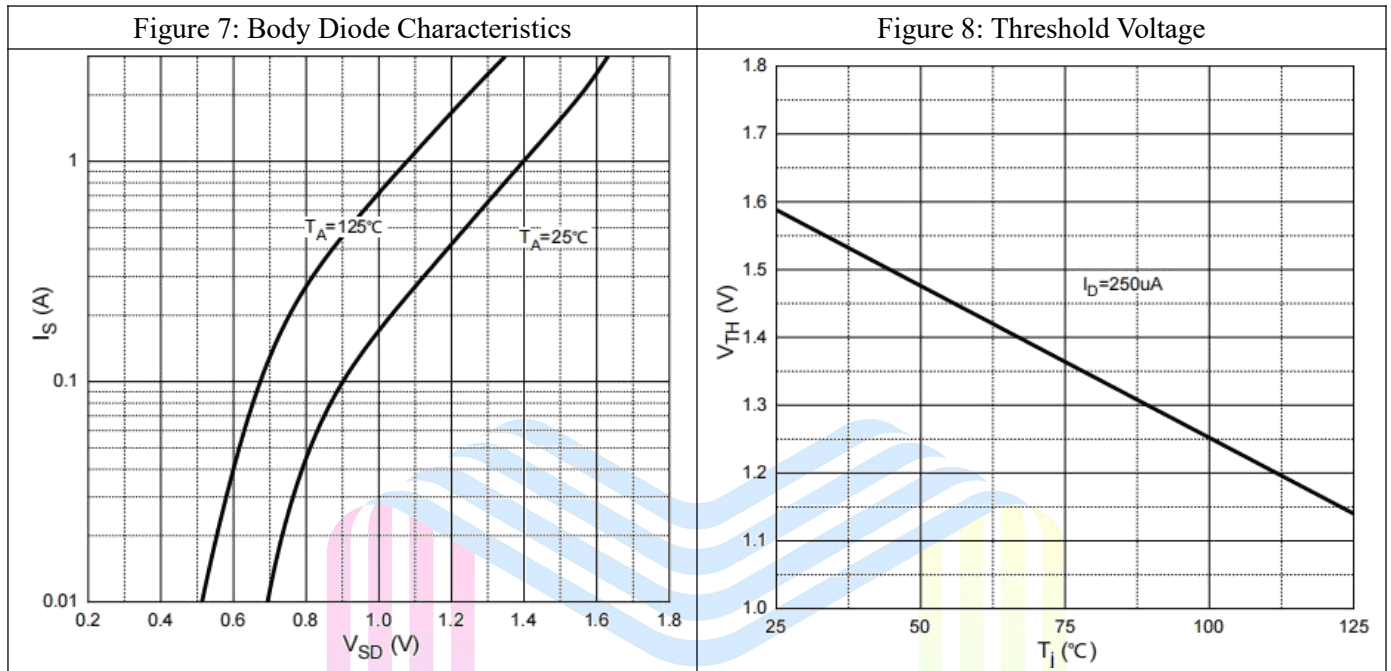
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Statistic Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	60			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=48V, V_{GS}=0V$			1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{GS} = \pm 20V, V_{DS}=0V$			± 5	μA
Gate Threshold Voltage ^{Note3}	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1.0	1.5	2.5	V
Static Drain-Source On-Resistance ^{Note3}	$R_{DS(on)}$	$V_{GS}=10V, I_D=0.3A$		1.8	3.5	Ω
		$V_{GS}=4.5V, I_D=0.2A$		2.1	4.0	
Forward transconductance ^{Note3}	g_{FS}	$V_{DS}=10V, I_D=0.2A$	80			mS
Dynamic Characteristics						
Input Capacitance	C_{ISS}	$V_{DS}=30V$		16.6		pF
Output Capacitance	C_{OSS}	$V_{GS}=0V$		1.79		pF
Reverse Transfer Capacitance	C_{RSS}	$f=1MHz$		2.38		pF
Total Gate Charge	Q_g	$V_{DS}=30V$		1.3		nC
Gate-Source Charge	Q_{gs}	$V_{GS}=10V$		0.14		
Gate-Drain Charge	Q_{gd}	$I_D=0.3A$		0.45		
Switching Parameters						
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=30V$		3.8		ns
Turn-on Rise Time	t_r	$V_{GS}=10V$		2.9		
Turn-off Delay Time	$t_{d(off)}$	$R_L=100\Omega$		14		
Turn-off Fall Time	t_f	$R_G=3\Omega$		8		
Diode Characteristics						
Diode Forward Voltage ^{Note3}	V_{SD}	$V_{GS}=0V, I_S=0.3A$			1.2	V

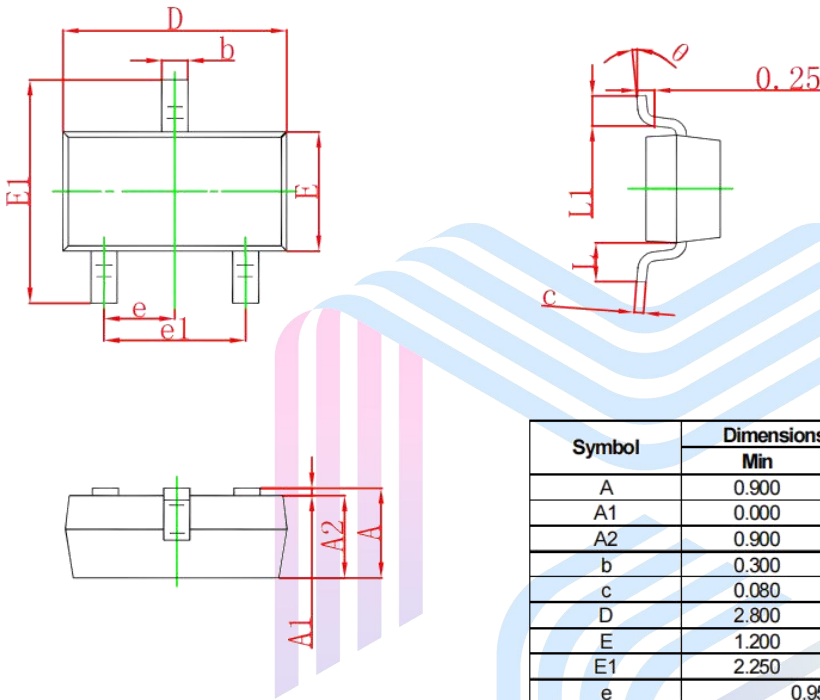
Notes :

1. The maximum current rating is limited by package. And device mounted on a large heatsink.
2. Pulse Test : Pulse Width $\leq 10\mu s$, duty cycle $\leq 1\%$.
3. Pulse Test : Pulse Width $\leq 300\mu s$, duty cycle $\leq 2\%$.
4. The power dissipation P_D is limited by $T_{J(MAX)} = 150^\circ\text{C}$. And device mounted on a large heatsink
5. Device mounted on 1in2 FR-4 board with 1oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$.

Typical Performance Characteristics






Mechanical Dimensions:
SOT-23 Package Information


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

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